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PRODUCT SPECIFICATIONS

SHARP

Mobile Liquid Crystal Displays Group

LQ022B8UD04

TFT-LCD Module

Spec. Issue Date: Dec. 27, 2003

No: LCY-303Z01

PREPARED BY: DATE	SHARP	SPEC No. LCY-303Z01
		FILE No.
APPROVED BY: DATE	MOBILE LIQUID CRYSTAL DISPLAY GROUP SHARP CORPORATION	ISSUE Dec.27.2003
		PAGE Pages 22
		APPLICABLE DIVISION ENGINEERING DEPARTMENT Ⅲ MOBILE LCD DESIGN CENTER Ⅰ MOBILE LIQUID CRYSTAL DISPLAY GROUP

SPECIFICATION

DEVICE SPECIFICATION for

TFT LCD Module

(176 × RGB × 220 dots)

Model No.

LQ022B8UD04

☐CUSTOMER'S APPROVAL

DATE

BY

PRESENTED BY

For

MASAKAZU.WADA

DIVISION DEPUTY GENERAL MANAGER
ENGINEERING DEPARTMENT Ⅲ
MOBILE LCD DESIGN CENTER Ⅰ
MOBILE LIQUID CRYSTAL DISPLAY GROUP
SHARP CORPORATION

SHARP

RECORDS OF REVISION	DOC. First issue	Dec. 27. 2003
	Model No.	LQ022B8UD04
	Spec. No.	LCY-303Z01

DATE	REF.PAGE PARAGRAPH DRAWING No.	REVISED NO.	SUMMARY	CHECK AND APPROVAL
Dec.27.2003			First Issue	

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[For handling and system design]

(1) Do not scratch the surface of the polarizer film as it is easily damaged.

(2) If the cleaning of the surface of the LCD panel is necessary, wipe it swiftly with cotton or other soft cloth. Do not use organic solvent as it damages polarizer.

(3) Water droplets on polarizer must be wiped off immediately as they may cause color changes, or other defects if remained for a long time.

(4) Since this LCD panel is made of glass, dropping the module or banging it against hard objects may cause cracks or fragmentation.

(5) Certain materials such as epoxy resin (amine's hardener) or silicone adhesive agent (de-alcohol or de-oxym) emits gas to which polarizer reacts (color change). Check carefully that gas from materials used in system housing or packaging do not hart polarizer.

(6) Liquid crystal material will freeze below specified storage temperature range and it will not get back to normal quality even after temperature comes back within specified temperature range. Liquid crystal material will become isotropic above specified temperature range and may not get back to normal quality. Keep the LCD module always within specified temperature range.

(7) Do not expose LCD module to the direct sunlight or to strong ultraviolet light for long time.

(8) If the LCD driver IC (COG) is exposed to light, normal operation may be impeded. It is necessary to design so that the light is shut off when the LCD module is mounted.

(9) Do not disassemble the LCD module as it may cause permanent damage.

(10) As this LCD module contains components sensitive to electrostatic discharge, be sure to follow the instructions in below.

① Operators

Operators must wear anti-static wears to prevent electrostatic charge up to and discharge from human body

charge up and discharge. Equipment must be grounded through 100Mohms resistance. Use ion blower.

③ Floor

Floor is an important part to leak static electricity which is generated from human body or equipment. There is a possibility that the static electricity is charged to them without leakage in case of insulating floor, so the countermeasure (electrostatic earth: $1\times10^{8}\Omega$) should be made.

④ Humidity

Proper humidity of working room may reduce the risk of electrostatic charge up and discharge. Humidity should be kept over 50% all the time.

⑤ Transportation/storage

Storage materials must be anti-static to prevent causing electrostatic discharge.

⑥ Others

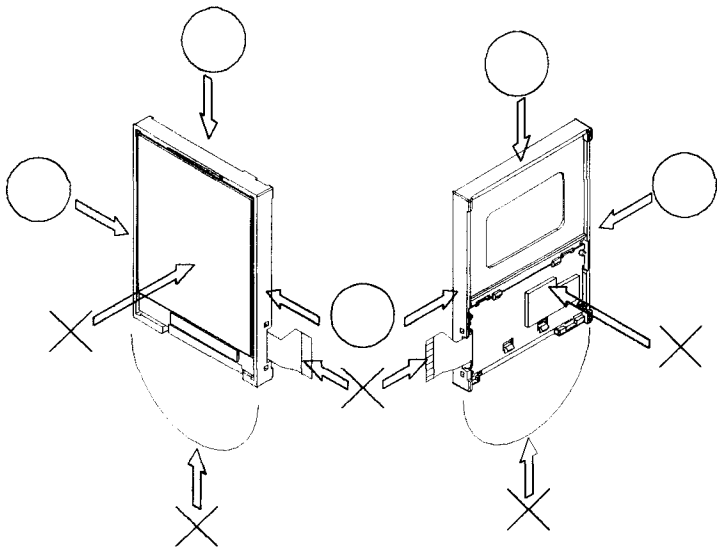
Protective film is attached on the surface of LCD panel to prevent scratches or other damages. When removing this protective film, remove it slowly under proper anti-ESD control such as ion blower.

(11) Hold LCD very carefully when placing LCD module into the system housing. Do not apply excessive stress or pressure to LCD module. Do not to use chloroprene rubber as it may affect on the reliability of the electrical interconnection.

(12) Do not hold or touch LCD panel to flex interconnection area as it may be damaged.

(13) As the binding material between LCD panel and flex connector mentioned in 12) contains an organic material, any type of organic solvents are not allowed to be used. Direct contact by fingers is also prohibited.

(14) When carrying the LCD module, place it on the tray to protect from mechanical damage. It is recommended to use the conductive trays to protect the CMOS components from electrostatic discharge. When holding the module, hold the Plastic Frame of LCD module so that the panel, COG and other electric parts are not damaged.



(15) Do not touch the COG's patterning area. Otherwise the circuit may be damaged.

(16) Do not touch LSI chips as it may cause a trouble in the inner lead connection.

(17) Place a protective cover on the LCD module to protect the glass panel from mechanical damages.

(18) LCD panel is susceptible to mechanical stress and even the slightest stress will cause a color change in background. So make sure the LCD panel is placed on flat plane without any continuous twisting, bending or pushing stress.

peeling off this protective film. Ion blower and ground strap are recommended.

(20) Make sure the mechanical design of the system in which the LCD module will be assembled matches specified viewing angle of this LCD module.

(21) This LCD module does not contain nor use any ODS (1,1,1-Trichloroethane, CCL4) in all materials used, in all production processes.

[For operating LCD module]

(1) Do not operate or store the LCD module under outside of specified environmental conditions.

(2) Do not display still picture or the display over 2 hours as this will damage the liquid crystal.

(3) As opto-electrical characteristics of LCD will be changed, dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable.

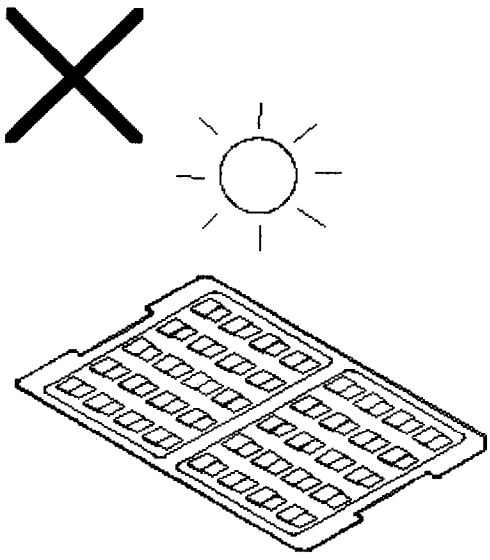
[Precautions for Storage]

(1) Do not expose the LCD module to direct sunlight or strong ultraviolet light for long periods. Store in a dark place.

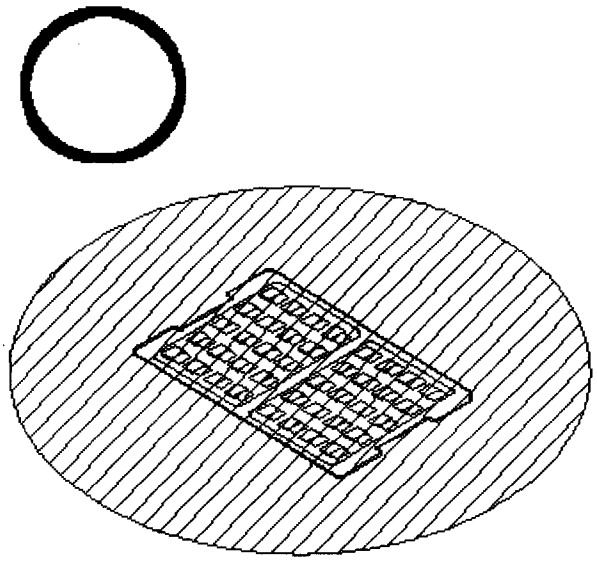
(2) The liquid crystal material will solidify if stored below the rated storage temperature and will become an isotropic liquid if stored above the rated storage temperature, and may not retain its original properties. Only store the module at normal temperature and humidity (25±5°C, 60±10%RH) in order to avoid exposing the front polarizer to chronic humidity.

(3) Keeping Method

a. Don't keeping under the direct sunlight.



b. Keeping in the tray under the dark place.



(4) Do not operate or store the LCD module under outside of specified environmental conditions.

(5) Be sure to prevent light striking the chip surface

[Other Notice]

(1) Do not operate or store the LCD module under outside of specified environmental conditions.

(2) As electrical impedance of power supply lines (VEE-VSS, VDD-VSS) are low when LCD module is working, place the de-coupling capacitor near by LCD module as close as possible.

(3) Reset signal must be sent after power on to initialize LSI. LSI does not function properly until initialize it by reset signal.

(4) Generally, at power on, in order not to apply DC charge directly to LCD panel, supply logic voltage first and initialize LSI logic function including polarity alternation. Then supply voltage for LCD bias. At power off, in order not to apply DC charge directly to LCD panel, execute Power OFF sequence and Discharge command.

(5) Don't touch to PWB surface, exposed IC chip, electric parts and other parts, to any electric, metallic materials.

(6) No bromide specific fire-retardant material is used in this module.

(7) Because including CMOS in this model, there is possibility that this module works wrongly by the noise from the antenna and so on. Please implement enough shields on user's product.

[Precautions for Discarding Liquid Crystal Modules]

COG : After removing the LSI from the liquid crystal panel, dispose of it in a similar way to circuit boards from electronic devices.

LCD panel : Dispose of as glass waste. This LCD module contains no harmful substances. The liquid crystal panel contains no dangerous or harmful substances. The liquid crystal panel only contains an extremely small amount of liquid crystal (approx.100mg) and therefore it will not leak even if the panel should break.

PWB/FPC : Dispose of as similar way to circuit board from electric device.

Contents Page

1. Application

This data sheet is to introduce the specification of LQ022B8UD04, active matrix 262,144 colors LCD module.
The LCD module controlled by Driver ICs (LR38825 / LH169CH).
If any problem occurs concerning the items not stated in this specification, it must be solved sincerely by both parties after deliberation.
As to basic specification of driver IC refer to the IC specification and handbook.

2. Construction and Outline

Construction: LCD panel, Driver (COG), FPC with electric components,
4 pieces White LED lump, prism sheet, diffuser, light guide and reflector, plastic frame to fix them mechanically.
Outline: See Fig.12 (page 22).
Connection: 35 pins; 0.3mm pitch ZIF FPC connector. Correspondable connector: FF02B35SS1 (JAE)

3. Mechanical Specification

Table 1

Parameter		Specifications	Unit
Outline dimensions *1		42.1 (W) × 56.6 (H) × 4.2 (D)	mm
LCD Panel	Active area	34.848 (W) × 43.56 (H)	mm
	Display format	176×RGB(W)×220(H)	-
	Dot pitch	0.066 (W) ×0.198 (H)	mm
	Base color *2	Normally white	-
Mass		Approx 12.1	g

*1 See Fig.12 (page 22)
*2 Due to the characteristics of the LC material, the colors vary with environmental temperature.

4. Absolute Maximum Ratings

(4-1) Electrical absolute maximum ratings

Table 2 Ta=25°C

Parameter	Symbol	Min	Max	Unit	Remark
Supply voltage for LCD	VEE-VSS	-0.3	4.0	V	VEE
Supply voltage for Logic	VDD-VSS	-0.3	4.0	V	VDD
Input Voltage	V_{IN}	-0.3	VDD+0.3	V	*1
LED forward current	I_{LED}	0	30	mA	*2

*1 Input terminal of logic system. : Voltage value is based on VSS = 0V.

*2 See (5-2) LED back light (page 9)

(4-2) Environment Conditions

Table 3

Item	Top		Tstg		Remark
	MIN.	MAX.	MIN.	MAX.	
Ambient temperature	-10 °C	+60°C	-20 °C	+70°C	Note 2)
Humidity	Note 1)		Note 1)		No condensation

Note1) Ta ≤ 40 °C.....95 % RH Max

Note2) Ta > 40 °C.....Absolute humidity shall be less than Ta=40 °C /95 % RH.

As opt-electrical characteristics of LCD will be changed, dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable. Be sure not to exceed the rated voltage, otherwise a malfunction may occur.

5. Electrical Specifications

(5-1) Electrical characteristics

Table 4 Ta=25°C, VEE=3.0V, VDD=3.0V, VSS=0V

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Applicable Pin
Supply voltage for LCD	VEE-VSS	Ta=-10~60 °C	2.8	3.0	3.2	V	VEE
Supply voltage for Logic	VDD-VSS	Ta=-10~60 °C	1.7	3.0	3.6	V	VDD
"H" level input voltage	V_{IH}	Ta=-10~60 °C	0.7VDD	-	-	V	(note1)
"L" level input voltage	V_{IL}		-	-	0.3VDD	V	
"H" level Input leakage current	I_{IH}	Ta=-10~60 °C V_{IN}= VSS or VDD	-	-	10	μA	(note2)
"L" level Input leakage current	I_{IL}		-10	-	-	μA	
"H" level output voltage	V_{OH}	Ta=-10~60 °C I_{OH}=-100μA, I_{OL}=100μA	0.8VDD	-	-	V	(note3)
"H" level output voltage	V_{OL}		-	-	0.2VDD	V	
Current consumption for LCD	I_{EE}	Ta=25 °C	-	5.5	8.0	mA	(note4)
Current consumption for Logic	I_{DD}			2.0	10.0	μA	

(note1) /WR, /CS, RS, /RD, /RES, D0~D15

(note2) /WR, /CS, RS, /RD, /RES, D0~D15

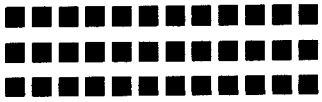
(note3) LCDINT

(note4) Following Conditions

Ta=25 °C, VDD=3.0V, VEE=3.0V, Frame frequency = 80Hz

Display Pattern: All Black. No Host CPU access.

*All Black pattern



(5-2) LED back light

(1) At LCD panel, the back light use 4pieces white LED.

Table 5

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Remark
Forward current	I_{LED}	Ta=25 °C	-	20	30	mA	CA

LED maker : NICHIA Corporation

LED type : NSCW335T

*Please consider Allowable Forward Current on used temperature
(refer to Ambient Temperature vs. Allowable Forward Current curve)

C21~C24 : 0.1μF / 10V

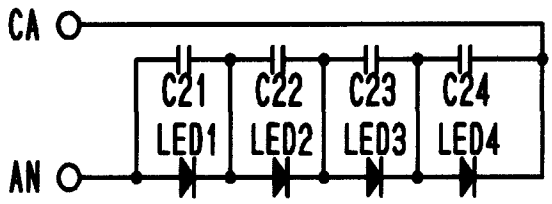


Fig.1 LED circuit

■ Ambient Temperature vs. Allowable Forward Current

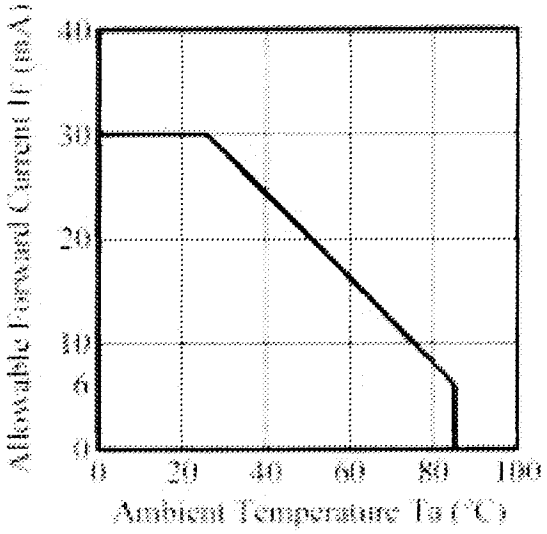


Fig.2 Ta vs. IF (NSCW335T)

[SPECIFICATIONS]

(1) Absolute Maximum Ratings Table 6 (Ta=25°C)

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	30	mA
Pulse Forward Current	IFP	100	mA
Reverse Voltage	VR	5	V
Power Dissipation	PD	120	mW

※Conditions : Pulse Width ≤ 10msec. and Duty ≤ 1/10

(2) Initial Electrical/Optical Characteristics Table 7 (Ta=25°C)

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF=20[mA]	-	3.6	4.0	V
Reverse Current	IR	VR=5[V]	-	-	50	μA

(5-3) Interface signals

Table 8

Pin No	Symbol	Description	I/O	Remark	
1	VSS	Ground level pin	-	-	
2	VSS	Ground level pin	-	-	
3	VEE	VEE level pin	-	For LCD driving	
4	D15	Data Bus (MSB)	I/O	(Note 1)	
5	D14	Data Bus	I/O	(Note 1)	
6	D13	Data Bus	I/O	(Note 1)	
7	D12	Data Bus	I/O	(Note 1)	
8	D11	Data Bus	I/O	(Note 1)	
9	D10	Data Bus	I/O	(Note 1)	
10	D9	Data Bus	I/O	(Note 1)	
11	D8	Data Bus	I/O	(Note 1)	
12	VSS	Ground level pin	-	-	
13	D7	Data Bus	I/O		
14	D6	Data Bus	I/O		
15	D5	Data Bus	I/O		
16	D4	Data Bus	I/O		
17	D3	Data Bus	I/O		
18	D2	Data Bus	I/O		
19	D1	Data Bus	I/O		
20	D0	Data Bus (LSB)	I/O		
21	VSS	Ground level pin	-		
22	VSS	Ground level pin	-		
23	/WR	Write control input pin	I	"L" active	
24	RS	Register select pin	I		
25	/CS	Chip select input pin	I	"L" active	
26	/RES	Reset signal input pin	I	"L" active	
27	VDD	VDD level pin	-	For Logic driving	
28	LCDINT	Interrupt request to the host bus	O	(Note 2)	
29	/RD	Read control input pin	I	"L" active	
30	IFM0	Selection signal pin for host interface mode	I	L	RS "H" : commands
				H	RS "L" : commands
31	BUS0	Selection signal pin for the width of data bus	I	L	8bit bus interface
				H	16bit bus interface
32	AN	LED back light for (Anode)	-	-	
33	AN	LED back light for (Anode)	-	-	
34	CA	LED back light for (Cathode)	-	-	
35	CA	LED back light for (Cathode)	-	-	

Used connection : 0.3mm pitch ZIF FPC connector.

Correspondable connector : FF02B35SS1 (JAE)

(Note 1) For unused Data Bus, connect to VSS.

(Note 2) If don't use "LCDINT" pin, leave it open.

(5-4) Host Interface Timing

(1) Write

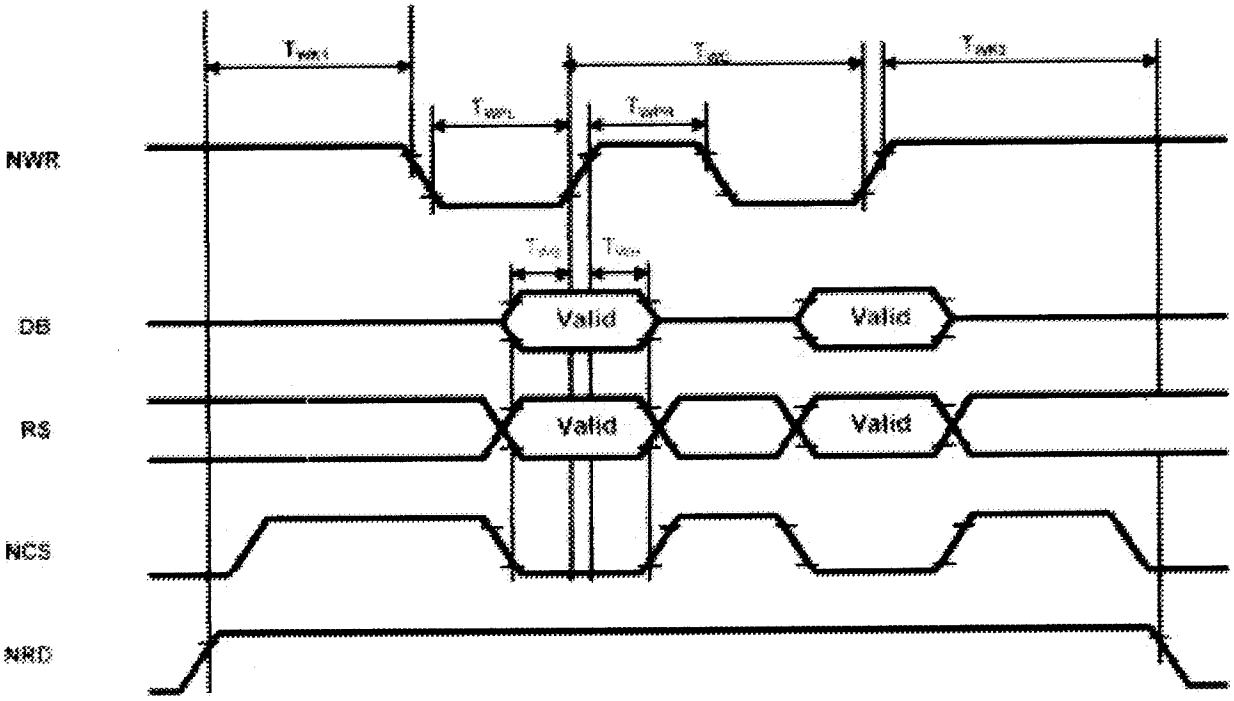


Fig.3 Host interface timing (Write)

Table 9

Symbol	Description	Min.	Max.	Note
T_{wwL}	Low period of NWR	60 ns	-	
T_{wwH}	High period of NWR	60 ns	-	
T_{wc}	Prohibit time re-writing	140 ns	-	
T_{wds}	Set up time of DB, RS and NCS to the NWR rising	50 ns	-	
T_{wdh}	Hold time of DB, RS and NCS to the NWR rising	0 ns	-	
T_{wrc}	Required time from the read cycle to write cycle	300 ns	-	
T_{rwc}	Required time from the write cycle to read cycle	300 ns	-	

Conditions: V_{DDIOW} = 1.65 V to 3.3 V, V_{DDCORE} = 1.8 ±0.15 V, T_{opr} = -30°C to +70°C, C_L = 10 pF
Reference input voltage: V_{IH} = 0.9 V_{DDIOW}, V_{IL} = 0.1 V_{DDIOW}
Reference output voltage: V_{OH} = 0.9 V_{DDIOW}, V_{OL} = 0.1 V_{DDIOW}

(2) Read

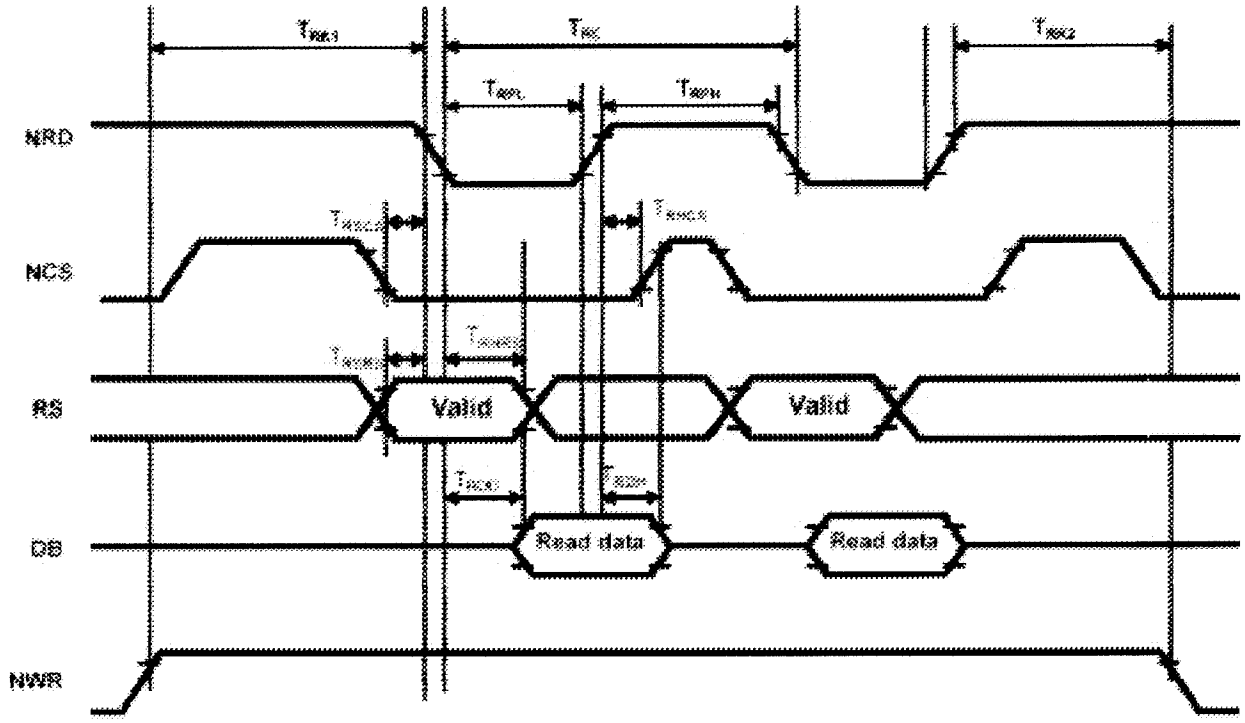


Fig.4 Host interface timing (Read)

Table 10

Symbol	Description	Min.	Max.
T_{RDL}	Low period of NRD	100ns	-
T_{RDH}	High period of NRD	100ns	-
T_{RC}	Prohibition time for re-reading	200ns	-
T_{RDRS}	Set up time of RS to NRD falling	50ns	-
T_{RDCS}	Set up time of NCS to NRD falling	50ns	-
T_{RSRD}	Hold time of RS from NRD falling	50ns	-
T_{CSRD}	Hold time of NCS from NRD rising	50ns	-
T_{RDD}	Time from NRD falling to confirmation of DB output	-	80ns
T_{RDH}	Time from NRD rising to confirmation of DB output	5ns	-

Conditions: V_{DDIOR} = 1.65 V to 3.3 V, V_{DDCORE} = 1.8 ±0.15 V, Topr = -30°C to +70°C, C_L = 10 pF
Reference input voltage: V_{IH} = 0.9 V_{DDIOR}, V_{IL} = 0.1 V_{DDIOR}
Reference output voltage: V_{OH} = 0.8 V_{DDIOR}, V_{OL} = 0.1 V_{DDIOR}

(5-5) Schematic of LCD module system

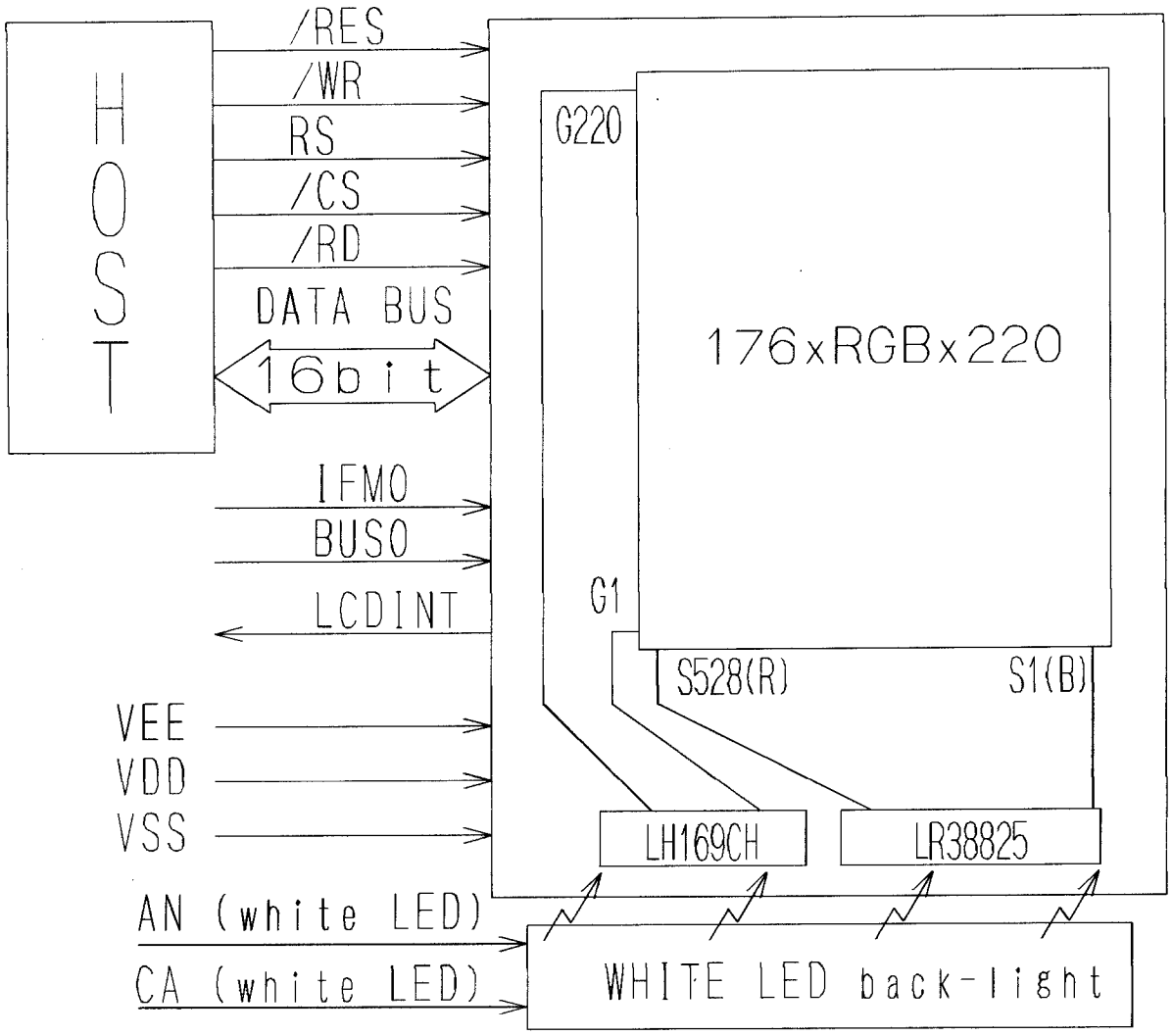


Fig.5 Schematic of LCD module system

(5-6) Power ON/OFF sequence

(1) Power ON

Table 11

Register	Command	Remarks
FD	FD	Software reset
FD	FD	
		WAIT (Min 50ms)
E0	01	Gate reset
		WAIT (Min 5μs)
E0	00	Gate reset release
FE	FE	Host reset
FE	FE	
EE	00	EEPROM I/F ready [Note]
		WAIT (Min 10ms)
EF	00	CPU bank active
10	08	Host Interface setting register (1)
12	AF	VRAM access area setting register (X direction/start and pointer)
13	DB	VRAM access area setting register (Y direction/start and pointer)
15	00	VRAM access area setting register (X direction/end)
16	00	VRAM access area setting register (Y direction/end)
18	03	Address auto increment setting register
88	00	Display displaying color setting register
7E	04	Display displaying setting register
		WAIT (Min 20ms)
7E	05	Display displaying setting register
7F	01	V sync parameter transfer flag
		【Write VRAM】
80	01	Display displaying control register (DIPS ON)

[Note]

A setup peculiar value to a panel is written in EEPROM.

【Cautions】 Please do not rewrite

(2) Power OFF

Table 12

Register	Command	Remarks
EF	00	CPU bank active
1B	04	Host reset enable
FE	FE	Host reset
FE	FE	
7E	04	Display setting
E3	04	Dc setting
E4	04	Dc setting
E2	01	Dc off setting
80	00	Display Off
E0	01	Gate reset
7F	01	TG parameter refresh
		WAIT (MIN 5 μ s)
E0	00	Gate reset release
7F	01	TG parameter refresh
		WAIT (MIN 5 μ s)
01	01	Oscillator stop
		【Power off】

6. Optical Characteristics

Table 13

Ta =25°C

Mode	parameter		symbol	condition	MIN	TYP	MAX	unit	Remark
Transmissive	Brightness		B	θ=0°	35	50	-	cd/m^2	Note 1,2
	Contrast		Co	θ=0°	40:1	60:1	-		Note 1,3
	Viewing Angle		θy-	Co > 5	20	30	-	deg	Note 1
			θy+		20	30	-		
			θx-		20	30	-		
			θx+		20	30	-		
	Response Time	Rise	τr1	θ=0°	-	18	35	ms	Note 1,4
		Decay	τd1		-	45	75	ms	
	White chromaticity		x	θ=0°	-	0.31	-		Note 1,3
			y		-	0.35	-		
Reflective	Reflectance		Rf	θ=0°	-	11	-	%	Note 5
	White chromaticity		x	θ=0°	-	0.30	-		Note 5
			y		-	0.34	-		

Note 1) Definition of range of visual angle

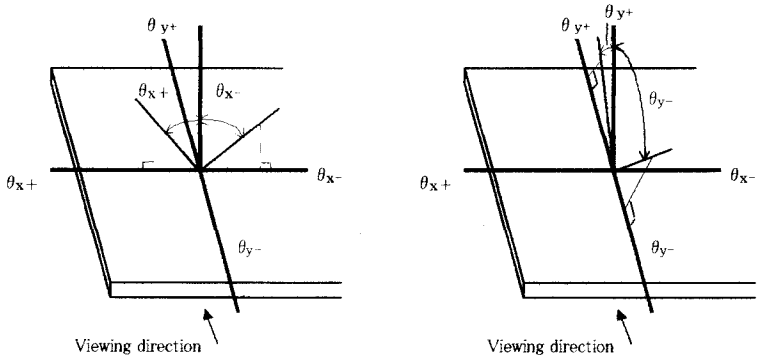
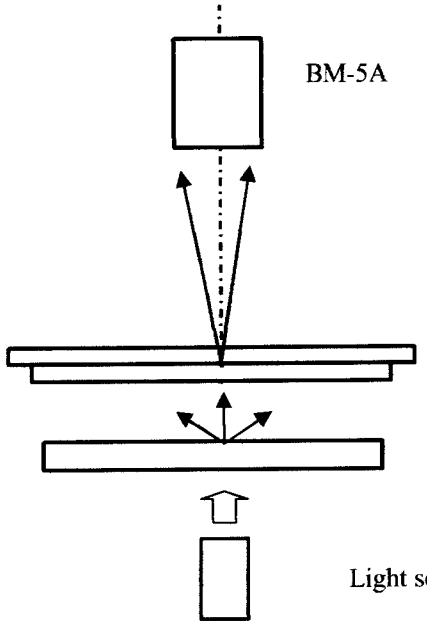


Fig.6 Definition of viewing angle

Note 2) Brightness is measured as shown in Fig.7, and is defined as the brightness of all pixels "White" at the center of display area on optimum contrast.



Measurement equipment:
TOPCON(BM-5A)
Measuring spot size 4.9 mm ϕ,
Measuring field 1.0°

Fig.7 Optical characteristics Test Method (Brightness)

Note 3) Contrast ratio is defined as follows:

$$Co = \frac{\text{Luminance(brightness) all pixcels "White"}}{\text{Luminance(brightness) all pixcels "dark"}}$$

Note 4) Response time is defined as follows:

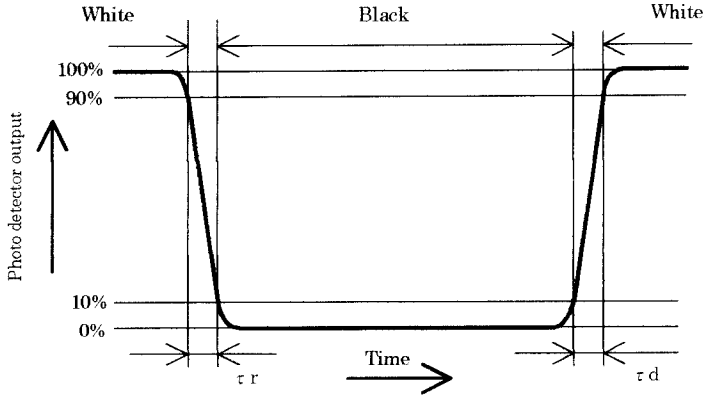


Fig.8 Response time (TFT)

Note 5) Reflectance is defined as follows:

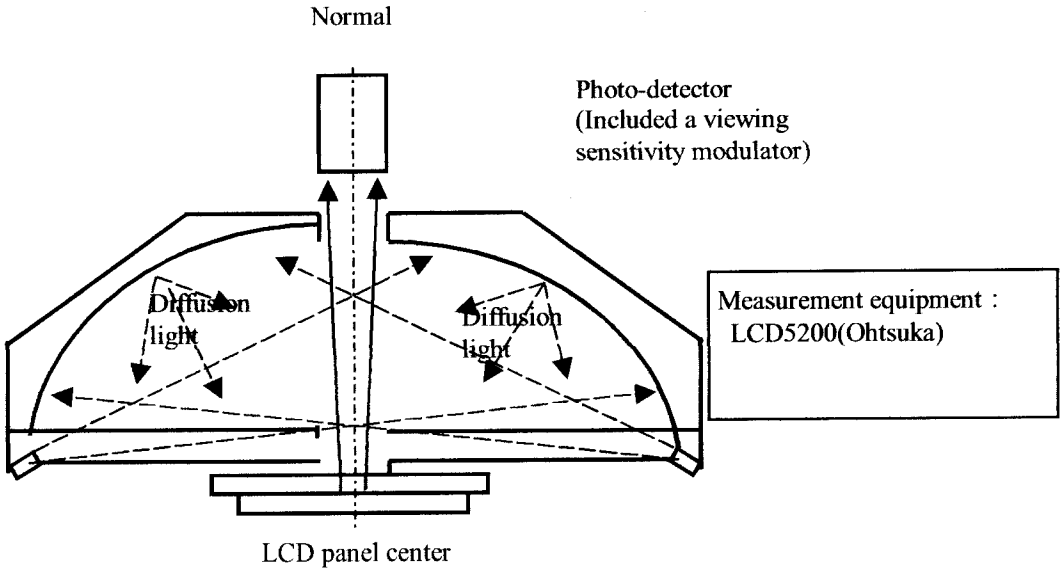


Fig.9 Optical Characteristics Test Method

7. Lot Number identification

Lot numbering and location are specified as follows.

03	L	000001	A	SC
①	②	③	④	⑤

①product year (lower 2 digits)

03:2003, 04:2004

②product month

A:JANUARY,B:FEBRUARY,C:MARCH.....L:DECEMBER

③Serial number

000001 ~ 999999

④Record of Revision

A:The first edition, B:Second edition

⑤product maker

SC:SHARP

8. Packing specifications

(8-1) Details of packing

1) Packing materials :Table.15

2) Packing style :Fig.11

(8-2) Reliability

1) Vibration test

Table.14

Item	Test			
Frequency	5 Hz to 50 Hz (3 minutes cycle)			
Direction	Up-Down, Left-Right, Front-Back (3 directions)			
Period	Up-Dow	Left-Right	Front-Back	Total
	60min	15min	15min	90min

The frequency should start at 5 Hz and vary continuously.

Total amplitude	20mm	0.2mm	20mm	0.2mm	
Frequency	5Hz	50Hz	5Hz	50Hz	(For 9.8m/s^2)
	O	O	O		
	| ←	3 minutes	→ |		

2) Drop test

Drop height: 750mm

(8-3)Packing quantities

250 modules (max) per master carton

(8-4)Packing weight

About 7.7kg

(8-5)Paking outline dimensions

382mm × 578mm × 255mm

(Packing materials) Table.15

	Parts name	Materials
1	Master carton	Corrugate card board
2	Under pad	Corrugate card board
3	Inside sleeve	Corrugate card board
4	Outside sleeve	Corrugate card board
5	Tray for packing	Polystyrene with anti-static treatment +anti-static polystyrene
6	OPP tape	Polypropylene
7	Protective bag	Polyethylene with anti-static treatment +anti-static polyethylene

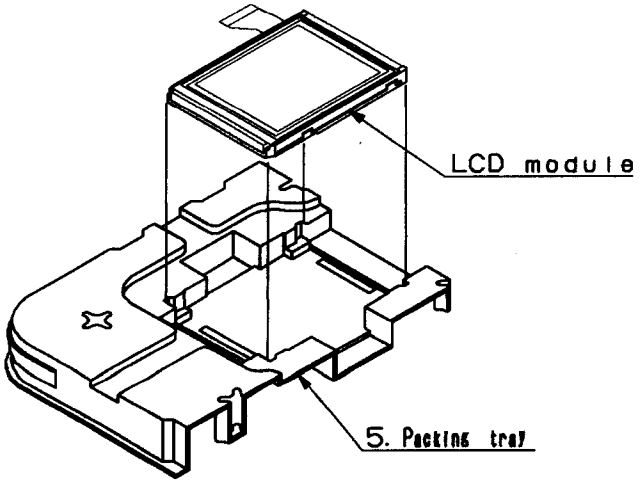
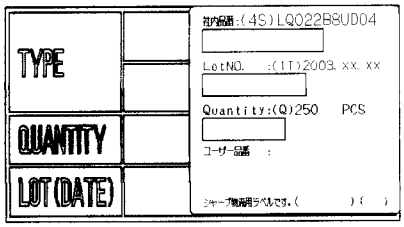


Fig.10

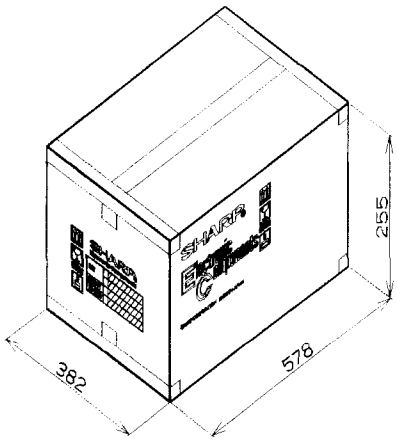


[Quantities]

1 tray : 25 modules(max)

1 sleeve:125 modules(MAX)

1 carton:250 modules(MAX)



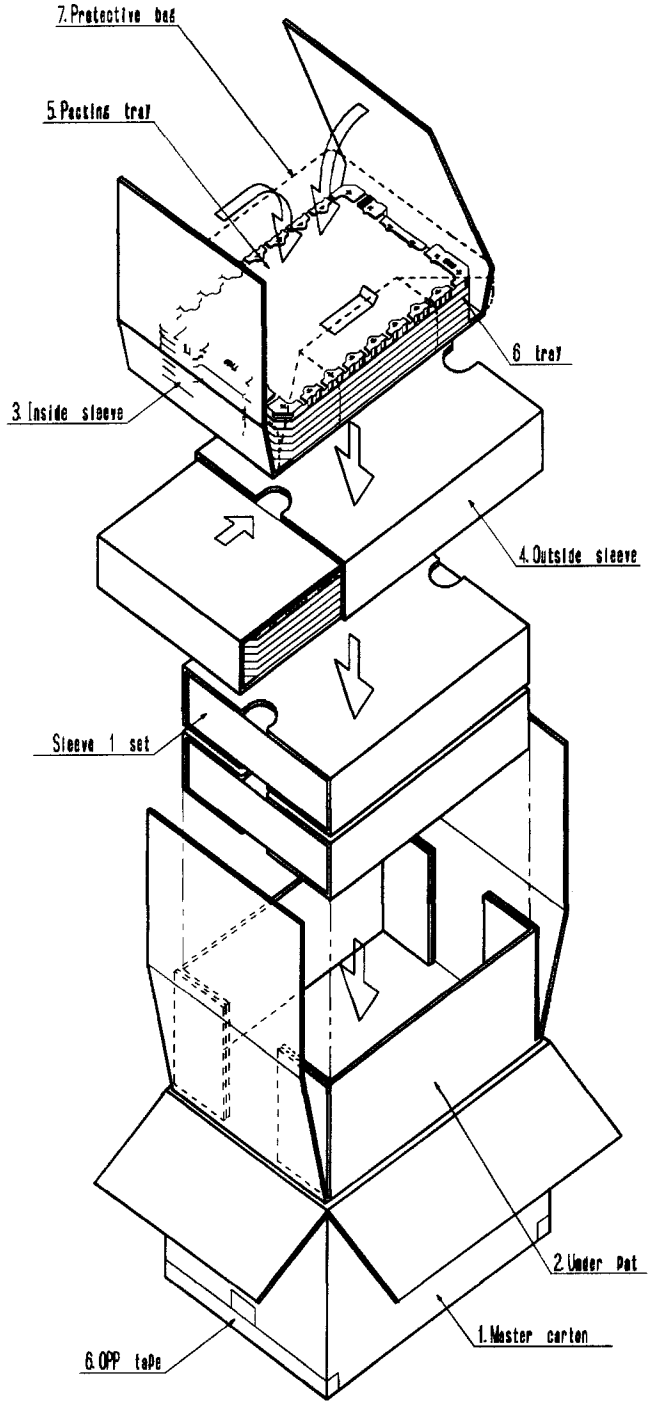


Fig.11

9. LCD module outline

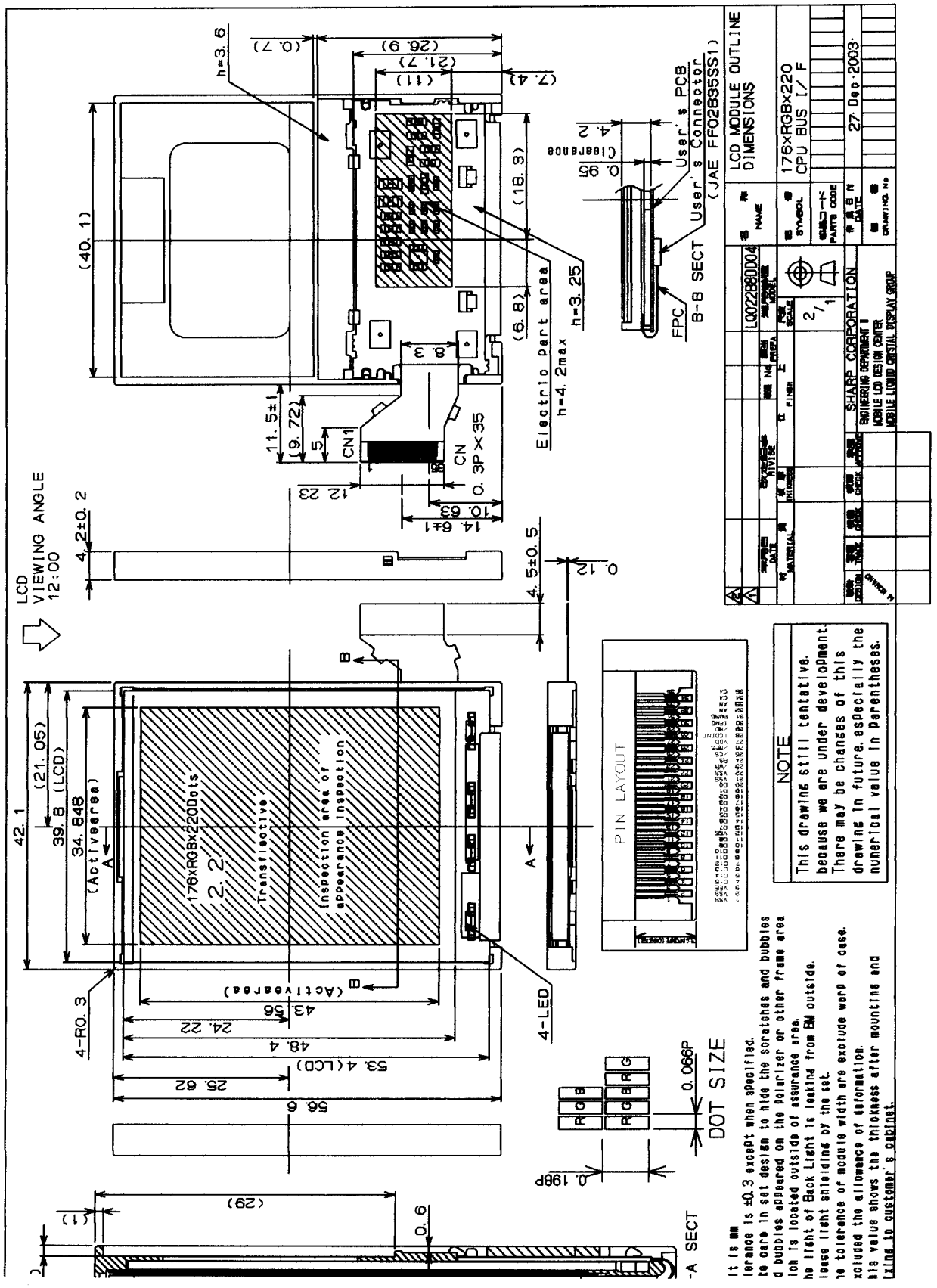


Fig. 12